


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	MDG/21/12675	
1.3 Title of PCN	ST Muar (Malaysia) LQFP7x7 32L line transfer for STM8S/L listed products	
1.4 Product Category	STM8L15x 32K STM8S20x 128K STM8S20x 32K STM8S20x 8K	
1.5 Issue date	2021-03-25	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.1.2 Marketing Manager	Veronique BARLATIER
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	ST MUAR (Malaysia)

4. Description of change

	Old	New
4.1 Description	ST MUAR LQ32 Matrix leadframe JSCC LQ32 High Density leadframe	ST MUAR LQ32 Matrix leadframe JSCC LQ32 High Density leadframe and ST MUAR LQ32 High Density leadframe
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact	

5. Reason / motivation for change

5.1 Motivation	material EOL
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	tracability ensured by ST internal tools
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7. Timing / schedule

7.1 Date of qualification results	2021-05-17
7.2 Intended start of delivery	2021-05-18
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	12675 MDG-MCD-RER2102 PCN12675 ST Muar LQFP7x7 32L line transfer for STM8S-L products reliability plan.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2021-03-25

9. Attachments (additional documentations)

12675 Public product.pdf
12675 MDG-MCD-RER2102 PCN12675 ST Muar LQFP7x7 32L line transfer for STM8S-L products reliability plan.pdf
12675 PCN12675_Additional information.pdf

10. Affected parts

10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM8L151K4T3	
	STM8L151K4T6	
	STM8L151K6T3	
	STM8L151K6T6	
	STM8L152K4T6	
	STM8L152K6T6	
	STM8S003K3T6C	
	STM8S005K6T6C	
	STM8S103K3T3C	
	STM8S103K3T6C	
	STM8S105K4T3C	
	STM8S105K4T6C	
	STM8S105K6T3C	
	STM8S105K6T6C	
	STM8S207K6T3C	
	STM8S207K6T6C	
	STM8S207K8T3C	
	STM8S207K8T6C	
	STM8S903K3T3C	

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